



ZXMN3A03E6

#### **Product Summary**

V <sub>(BR)DSS</sub>	Max R <sub>DS(ON)</sub>	Max I <sub>D</sub> T <sub>A</sub> = +25°C	
30V	$0.050\Omega @ V_{GS} = 10V$	4.6A	

# **Description and Applications**

This new generation of TRENCH MOSFET from Zetex utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, power management applications.

- DC DC converters
- Power Management Functions
- Disconnect Switches
- Motor Control

#### **30V N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Features and Benefits**

- Low On-resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

Case: SOT26

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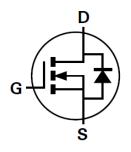
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (63)
- Weight: 0.015 grams (Approximate)



SOT26

Top View





**Device Symbol** 

# Ordering Information (Note 4)

Part Number	Reel Size (inch)	Tape Width (mm)	Quantity Per Reel
ZXMN3A03E6TA	7	8	3000
ZXMN3A03E6TC	13	8	10,000

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

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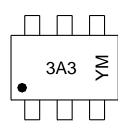
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2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**



3A3 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: C = 2015) M or  $\overline{M}$  = Month (ex: 9 = September)

Date Code Key

Notes:

Dale Coue	Кеу												
Year	201	5 3	2016	2017	2018	2019	2020	202	1 20	22	2023	2024	2025
Code	С		D	E	F	G	Н	I		J	K	L	М
Mont	h	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code		1	2	3	4	5	6	7	8	9	0	Ν	D



#### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Characteristic		Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	30	V
Gate-Source Voltage			V <sub>GS</sub>	±20	V
		T <sub>A</sub> = +25°C (Note 6)	ID	4.6	
Continuous Drain Current	$V_{GS} = 10V$	$T_A = +70^{\circ}C$ (Note 6)		3.7	А
		T <sub>A</sub> = +25°C (Note 5)		3.7	
Pulsed Drain Current (Note	7)	• • • •	I <sub>DM</sub>	17	A
Continuous Source Current	(Body Diode) (N	lote 6)	Is	2.6	A
Pulsed Source Current (Bod	y Diode) (Note	7)	I <sub>SM</sub>	17	A

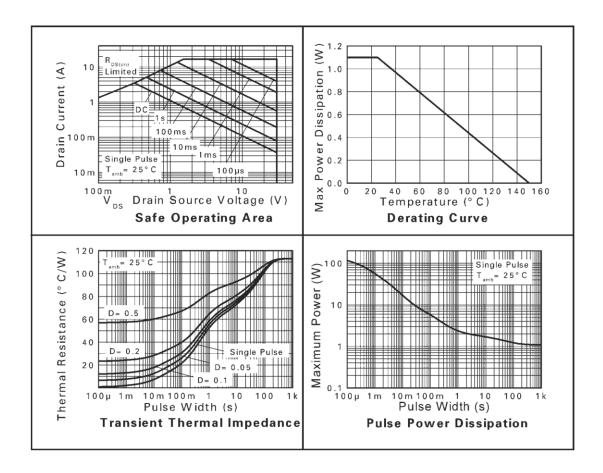
## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation at $T_A = +25^{\circ}C$ (Note 5) Linear derating factor (Note 5)	PD	1.1 8.8	W mW/°C
Power Dissipation at $T_A = +25^{\circ}C$ (Note 6) Linear derating factor (Note 6)	P <sub>D</sub>	1.7 13.6	W mW/°C
Junction to Ambient (Note 5)	R <sub>0JA</sub>	113	°C/W
Junction to Ambient (Note 6)	R <sub>θ</sub> JA	73	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	۵°

Notes: 5. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions. 6. For a device surface mounted on FR-4 PCB measured at t≦10 secs.

7. Repetitive rating 25mm x 25mm FR-4 PCB, D = 0.05, pulse width 10µs - pulse width limited by maximum junction temperature. Refer to Transient Thermal Impedance graph.

### **Thermal Characteristics**





#### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

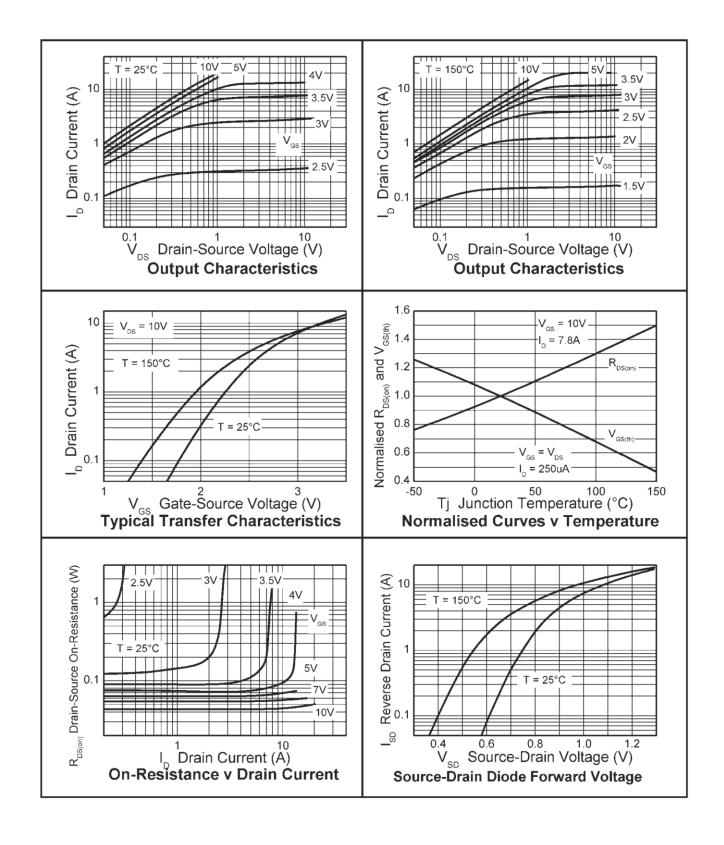
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-source Breakdown Voltage	BV <sub>DSS</sub>	30	—	_	V	$I_D = 250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	IDSS	_	_	0.5	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-body Leakage	I <sub>GSS</sub>	_	_	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS						·	
Gate-source Threshold Voltage	V <sub>GS(th)</sub>	1	_	—	V	$I_D = 250 \mu A$ , $V_{DS} = V_{GS}$	
Statia Drain course On state Resistance (Note 8)	D			0.050	Ω	$V_{GS} = 10V, I_D = 7.8A$	
Static Drain-source On-state Resistance (Note 8)	R <sub>DS</sub> (ON)	_	_	0.065	12	$V_{GS} = 4.5 V, I_D = 6.8 A$	
Forward Transconductance (Notes 8 & 10)	<b>g</b> fs	-	10	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 7.8A	
Diode Forward Voltage (Note 8)	V <sub>SD</sub>	_	0.85	0.95	V	T <sub>J</sub> = +25°C , I <sub>S</sub> = 3.2A, V <sub>GS</sub> = 0V	
DYNAMIC CHARACTERISTICS (Notes 9 & 10)						·	
Input Capacitance	Ciss		600	-	pF		
Output Capacitance		_	104	_	pF	−V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V −f = 1MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	-	58.5	_	pF		
Gate Charge	Qg	_	6.9	—	nC	V <sub>GS</sub> = 5V, V <sub>DS</sub> = 15V I <sub>D</sub> = 3.5A	
Total Gate Charge	Qg		12.6	-	nC		
Gate-source Charge	Q <sub>gs</sub>	_	2.0	—	nC	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 15V - I <sub>D</sub> = 3.5A	
Gate-drain Charge		_	2.0	_	nC	ID = 3.5A	
Reverse Recovery Time (Note 10)		_	18.8	_	ns	T <sub>J</sub> = +25°C, I <sub>F</sub> =3.5A,	
Reverse Recovery Charge (Note 10)	Q <sub>rr</sub>	_	14.1	_	nC	di/dt= 100A/µs	
Turn-on Delay Time			2.9	—	ns		
Turn-on Rise Time			6.4	—	ns	V <sub>DD</sub> = 15V, V <sub>GS</sub> = 10V	
Turn-off Delay Time	t <sub>d(off)</sub>	_	16.0	—	ns	$I_D = 3.5A, R_G = 6.0\Omega$	
Turn-off Fall Time	t <sub>f</sub>		11.2	_	ns	7	

Notes:

8. Measured under pulsed conditions. Width=300µs. Duty cycle ≤ 2%.
9. Switching characteristics are independent of operating junction temperature.
10. For design aid only, not subject to production testing.

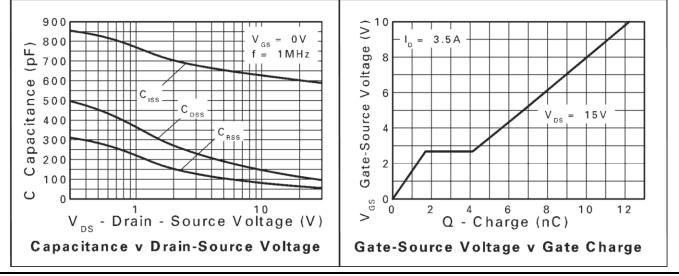


# **Typical Characteristics**

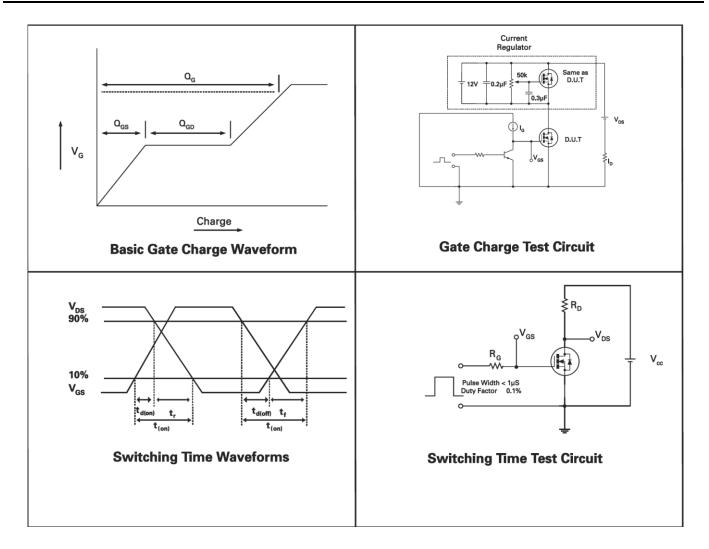




# Typical Characteristics (Cont.)



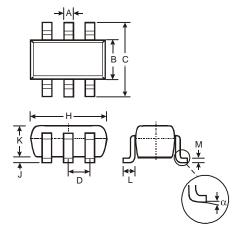
# **Test Circuits**





# **Package Outline Dimensions**

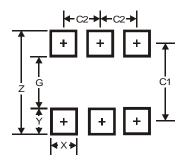
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT26						
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D			0.95				
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
Κ	1.00	1.30	1.10				
L	0.35	0.55	0.40				
М	0.10	0.20	0.15				
α	0°	8°	—				
Ali D	imensi	ons in	mm				

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	3.20
G	1.60
Х	0.55
Y	0.80
C1	2.40
C2	0.95



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